Docket No.: LSG0174US

FORM PTO-1595 (Modified)	RECORDATION FO	U.S. DEPARTMENT OF COMMERCE					
(Rev. 03-09) OMB No. 0851-0027 (exp.3/31/2009) P08A/REV06	PATEN1	S ONLY	Patent and Trademark Office				
To the Director of the United States Pal	tent and Trademark Office: P	lease record the attached document	s or the new address(es) below.				
1. Name of conveying party(ies): Lamina Lighting, Inc. LLI Aquisition, Inc.	i.es.	2. Name and address of receiving party(ies): Name: Lighting Science Group Corporation Address: 1227 South Patrick Drive, Bldg. 2A					
Additional names(s) of conveying party(ies)	☐ Yes 🏿 No						
3. Nature of conveyance/Execution							
Execution Date(s): 7-29-2008, 7-29	9-2008, 7-9-2009						
☑ Assignment		City: Satellite Beach					
☐ Security Agreement	Change of Name	State/Prov.: Florida					
 □ Joint Research Agreement □ Government Interest Assignmer □ Executive Order 9424, Confirmation □ Other 		Country: USA Additional name(s) & address(es) attack	ZIP: <u>32937</u> ched? □ Yes ⊠ No				
		This document is being filed to					
4. Application or patent numbers(s A. Patent Application No. (s) 08/812172	.	B. Patent No.(s)	gener wan a new application.				
5. Name and address to whom cor concerning document should be		6. Total number of application involved:	ns and patents				
Name: David Arnold		7. Total fee (37 CFR 1.21(h) &					
Registration No.: 48,894		7. Total fee (37 CFR 1.23(11) &	3.41) \$ 40.00				
Address: Cantor Colburn LLP		☐ Authorized to be charged	by credit card				
20 Church Street, 22nd Floor							
City: Hartford			ent interest not affecting title)				
State/Prov.: CT		8. Payment Information					
	ZIP: 06103	a. Credit Card Last 4 Num	bers				
Phone Number: 860-286-2929		Expiration Date					
Fax Number: 860-286-0115		b. Deposit Account Number					
Email Address: tlanthjer@cantorco	lburn.com	Authorized User Name	David Arnold				
9. Signature:			July 29, 2009				
	Signature		Date				
Na	Arnold, Reg. No. 48,894 me of Person Signing		number of pages including cover attachments, and document:				

Mail Stop Assignment Recordation Services, Director of the USPTO, P.D. Box 1450, Alexandria, VA 22313-1450

Execution Copy

PATENT ASSIGNMENT

WHEREAS LAMINA LIGHTING, INC., a Delaware corporation, having a place of business at 120 Hancock Lane, Westampton, New Jersey 08060, U.S.A. (hereinafter referred to as ASSIGNOR), has been assigned certain rights, title and interests in and to the patents applications and patents listed in Schedule A hereto and to the inventions described and claimed therein; and

WHEREAS LLI ACQUISITION, INC., a Delaware corporation, having a place of business at 2100 McKinney Avenue, Suite 1515, Dallas, Texas 75201 (hereinafter referred to as ASSIGNEE), is desirous of acquiring ASSIGNOR's entire right, title and interest in and to the patent application and patents in the United States of America and elsewhere worldwide, and the inventions therein described and claimed;

NOW, THEREFORE, in consideration of the good and valuable consideration furnished by ASSIGNOR to ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby assigns, conveys and transfers to ASSIGNEE, its successors and assigns, ASSIGNOR's entire right, title and interest in and to the said patent applications and patents and the inventions therein described and claimed, including its right to apply for any Letters Patent in any and all countries on the inventions, and any Letters Patents that may be or have been issued thereon or therefore, in the United States and elsewhere, and all reissues, extensions, renewals, divisions and continuations thereof, to the full end of the term or terms for which the Letters Patents may be issued or have been issued, the same to be held and enjoyed by ASSIGNEE, its successors and assigns, the same as it would have been held and enjoyed by ASSIGNOR if this Assignment had not been made.

And ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks and similar authorities to issue and transfer all such Letters Patents to ASSIGNEE, its successors and assigns, in accordance with this instrument of Assignment.

ASSIGNOR hereby represents and warrants that there are no rights and interests outstanding inconsistent with the rights and interests granted herein and that it will not execute any instrument or grant or transfer any rights or interests inconsistent therewith, and ASSIGNOR

Jul 29 2009 3:05PM

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And ASSIGNOR further covenants and agrees, in consideration of the premises that ASSIGNOR will at any time upon request communicate to ASSIGNEE, its successors and assigns, any facts relating to the invention and improvements and the history thereof, known to ASSIGNOR and that ASSIGNOR will testify as to the same in any interference, or other litigation when requested so to do by ASSIGNEE, its successors and assigns.

2

IN TESTIMONY WHEREOF, ASSIGNOR has hereunto set its hand and seal this 29th day of July, 2008.

LAMINA LIGHTING, INC.

BY:

NAME:

Frank Shinneman

TITLE:

President and Chief Executive Officer

The undersigned is authorized to act on behalf of ASSIGNEE.

IN TESTIMONY WHEREOF, ASSIGNEE has hereunto set its hand and seal this 29th day of July, 2008.

LLI ACQUISITION, INC.

BY:

NAME:

Govi Rao

TITLE:

President

SIGNATURE PAGE TO PATENT ASSIGNMENT

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LAMINA LIGHTING, INC.

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NAME:

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LLI ACQUISITION, INC.

BY:

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Govi Rao

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President

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SCHEDULE A

2 PATTI 3 PATTI 3 Method 3 pattern 13 ELEC 14 EMBC 15 Method 22 EXTE 32 HIGH 33 HIGH 34 APPA 1NTEG 41 CONN 45 LED 1 41 CONN 45 LED 1 46 CIRC CONC 77 TECE 40 LOW 77 TECE 41 SUPP 88 MINI 89 MON 113 COL 114 SHEI 114 SHEI 115 TUN 119 ELEC 1 A LICO 119 TEM 110 TEM 110 TEM 111 TEM 111 TEM 112 COL 113 COL 114 SHEI 115 COL 115 COL 116 TEM 117 TEM 118 SHEI 119 LEG 110 TUN 119 ELEC 110 TUN 110 TUN 111 ELEC 110 TUN	,	COUNTRY	DATE	SERIAL NO	DATE	PATENT NO	STATUS	Assignment
Method Pattern	MIC MULTILAYER CIRCUIT BOARDS MOUNTED ON A	UNITED STATES		09/852,901		6518502	ISSUED	LAMINA
3 pattern 13 ELEC 14 EMBC 15 Metho 16 Metho 21 EXTE 32 HIGH 33 High I 34 APPA 10 TEMF 39 TECH 41 CONT 45 LED I 46 LED I 67 TECH 68 MINI 88 MINI 89 MON 114 SHEI 114 SHEI 1 AND 115 COL 1 AND 116 TEMF 30 MON 117 TEMF 118 COL 119 ELEC 1 AND 110 SF7 1 IUST 1 AND 1 ELEC 1 AND	ERNED METAL SUPPORT SUBSTRATE ad of making ceramic multilayer circuit boards mounted in a	UNITED STATES	BOT TOTAL					LAMINA
14 EMBC 15 Metho 16 HIGH 22 EXTE 32 HIGH 33 High F 16 LUV 16 ED J 17 TECH 16 LIGH 60 TEMH 60 TEMH 60 TEMH 61 LIGH 63 TECH 64 LIGH 65 LIGH 65 LIGH 66 TEMH 67 TECH 67 TECH 68 MINI 68 MON 113 COL 114 SHEI 1 AND 119 ELEC 1 AND 110 ELEC 1 AND 110 ELEC 1 AND 111 ELEC 1 AND 112 ELEC 1 AND 113 COL 1 AND 1 ELEC 1 AND	ned metal support substrate	UNITED STATES	10/30/02	10/284,544	25-May-04	6739047	ISSUED	
14 EMBC 15 Metho 16 HIGH 22 EXTE 32 HIGH 33 High F 16 LUV 16 ED J 17 TECH 16 LIGH 60 TEMH 60 TEMH 60 TEMH 61 LIGH 63 TECH 64 LIGH 65 LIGH 65 LIGH 66 TEMH 67 TECH 67 TECH 68 MINI 68 MON 113 COL 114 SHEI 1 AND 119 ELEC 1 AND 110 ELEC 1 AND 110 ELEC 1 AND 111 ELEC 1 AND 112 ELEC 1 AND 113 COL 1 AND 1 ELEC 1 AND	TRONIC CIRCUIT CHIP PACKAGE	UNITED STATES	12/16/98	08/768,062	08-Dec-98	5847935	ISSUED	LAMINA
16 Metho HIGH 22 EXTE 33 High F 10 HIGH 34 APPA 11 HIGH 39 TECH 10 HIGH 39 TECH 10 HIGH 60 TEMI 60 TEMI 64 Light 65 Light 77 TECH 10 CON 78 LTCC 10 WETH 10 SUPF 88 MINI 89 MON 1 TEM 114 SHEI 1 TUN 119 ELES 7 MIX 9 LIGH 46 THE 50 Light 50 Light 50 Light 51 INC. 51 INC. 51 INC. 51 INC. 51 INC. 55 Light 59 C		UNITED STATES		09/127,425		6140759	ISSUED	LAMINA LAMINA
22 EXTE 32 HIGH 33 HIGH 33 HIGH 34 APPA 41 CONT 45 LED 1 45 LED 1 46 LIGH 60 TEME 65 LIGH 67 TECE 68 MINI 89 MON 113 COL 114 SHEI 114 SHEI 1 TUN 119 ELEC 1 AND 119 ELEC 1 AND 119 ELEC 1 AND 119 ELEC 1 AND 110 ELEC 1 AND 111 ELEC 1 AND 112 ELEC 1 AND 114 SHEI 1 AND 1 TUN 115 ELEC 1 AND 1 TUN 116 ELEC 1 AND 117 ELEC 1 AND 1 TUN 118 ELEC 1 AND 1 TUN 119 ELEC 1 AND 1 ELEC 1 AND 1 ELEC 1 E	od for making an embossed plasma display back pane	UNITED STATES	09/11/00	09/659,234	26-Mar-02	6361390	ISSUED	LAMINA
32 HIGH 33 High F 10 ILUV 11 APPA 11 TEMF 39 TECH 12 LED / 14 LED / 15 LED / 16 LIGH 60 TEMF 65 Light 16 CINC 16 CINC 17 TECF 18 LTCC 18 MET 18 MON 113 COL 114 SHE 114 SHE 114 SHE 115 LIGH 115 LIGH 116 LIGH 117 LIGH 118 LIGH 119 LIGH 119 LIGH 110 LIGH 110 LIGH 110 LIGH 111 SHE 111 LIGH 112 LIGH 113 COL 114 SHE 115 LIGH 115 LIGH 116 THE 117 LIGH 118 LIGH 119 LIGH 119 LIGH 110 LIG	DIELECTRIC CONSTANT BURIED CAPACITORS WITH		11404700	09/434,059	09-Oct-01	6300267	ISSUED	LAMINA
33 High F ILLUN BMIT ILLUN BMIT ILLUN BMIT 34 APPA APPA ILTO ILTO	NDED OPERATING TEMPERATURE RANGES PERFORMANCE EMBEDDED RF FILTERS	UNITED STATES UNITED STATES	10/28/99	09/430,642	05-Jul-05	6914501	ISSUED	LAMINA
ILLUM BMIT 34 APPA INTEG 1 CONT 45 LIGH 65 LIGH 65 LIGH 67 CONT 78 C	performance embedded RF filten	UNITED STATES	05/24/05	11/135,764	14-Mar-06	7011725	ISSUED	LAMINA
11 TEC 1 TEC	MINATION DEVICES COMPRISING WHITE LIGHT TING DIODES AND DIODE ARRAYS AND METHOD AND	UNITED STATES	04/09/04	10/822,236	02-Jan-07	7157745	ISSUED	LAMINA
39 TEMF 39 TECH	RATUS FOR MAKING THEM GRATED HEAT SINKING PACKAGES USING LOW	OMITED CITATION	<u> </u>					
39 TECH 41 LED 4 41 CONT 45 LED 3 45 LED 3 46 LEGH 65 Light 65 Light 76 CIRC LOW 77 TECH METT CONT 78 LTCC 81 SUPF 88 MINI 113 COLT 114 SHEI 1 AND DISF 7 MIX 9 LIGH 46 THB 50 Light 1 LIGH 51 LIGH 58 LIGH 59 LIGH 59 LIGH 59 LIGH 59 LIGH 59 LIGH 59 LIGH 51 LIGH 59 LIGH 50	PERATURE COFIRED CERAMIC METAL CIRCUIT BOARD	Ì			24-Sep-02	CAECDAN	ISSUED	LAMINA
41 CON1 45 LED 1 LIGH 60 TEMI 60 TEMI 60 LIGH 60 CIRC LOW 76 CIRC CON 78 LTCC METI CON 78 LTCC 110 LIGH 114 SHEI 1 AND DISP 7 MIX 9 LIGH 46 THE 50 LIGH 51 INC 58 LIGH 59	INOLOGY	UNITED STATES	09/18/09	09/664,599	24-Sep-02	6450930	JOGUCE	
45 LED 1 LIGH 60 TEMI 84 Light 65 Light 16 CON 76 CIRC 17 TEGC 81 SUPF 88 MINI 89 MON 114 SHEI 114 SHEI 1 AND 2 AN	ARRAY PACKAGE WITH INTERNAL FEEDBACK AND	UNITED STATES	07/19/04	10/894,185	07-Aug-07	7252408	ISSUED	LAMINA
LIGH 60 TEMI 64 Light 65 Light 67 TEMI 67 TE	TROL LIGHT SOURCES FOR IMAGE PROJECTION SYSTEMS	UNITED STATES		-458948	27-Nov-07	7300182	ISSUED	LAMINA
60 TEMI 64 Light 65 Light 67 TEMI 67 T	IT EMITTING DIODES PACKAGED FOR HIGH			10/005	30 4	7005052	ISSUED	LAMINA
85 Light CONT TECH METT 88 MINI 89 MON 113 COLM 114 SHEI 1 AND DISF 7 MIX 9 LIGH 65 Light 59 COL 65 Light 59 COL 65 Light 66 COL 67 COL 68 COL 69 C	PER ATURE OPERATION	UNITED STATES	08/11/03		22-Aug-06 29-Aug-06		ISSUED	LAMINA
76 CIRC METI CON 78 LTCF 81 SUPF 88 MINI 89 MON 113 COL 114 SHEI 1 AND DISP 7 MIX 9 LIGH 46 THE 50 Ligh 51 INC 58 Ligh 59	emitting diodes packaged for high temperature operation emitting diodes packaged for high temperature operation	UNITED STATES		11/083,862	13-Feb-07		ISSUED	LAMINA
76 CIRC LOW 77 TECH CON 78 LTCC 81 SUFF 88 MINI 89 MON 113 COL 114 SHEI 1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh 51 INC. 58 Ligh 59	TEMPERATURE CO-FIRED CERAMIC-METAL					W00544D	ISSUED	LAMINA
77 TECH METT CONT 78 LTCC METT SUPP 88 MINI TEM 113 COL TEM 114 SHEI TUN 119 ELEC ALICU ST MIX 9 LIGH 46 THE 50 LIGH SUPP SE LIGH SUPP SE	CULATORS AND ISOLATORS	UNITED STATES	02/28/06	11/364,272	26-Feb-08	7336140	130000	D divin to
78 LTCC 81 SUPF 88 MINI 89 MON 113 COL 114 SHEI 114 SHEI 1 AND 0 DISF 7 MIX 9 LIGH 46 THE 50 Ligh LIGH 51 INC 58 Ligh 59	TEMPERATURE CO-FIRED CERAMIC-METAL PACKAGING HNOLOGY	UNITED STATES	07/19/02	10/199.418	30-Mar-04	6713862	ISSUED	LAMINA
78 LTCC 81 SUPF 88 MINI 89 MON 113 COL 114 SHEI 1 AND 0 DISF 7 MIX 9 LIGH 46 THE 50 Ligh LIGH 51 INC 58 Ligh 59	HOD AND STRUCTURES FOR ENHANCED TEMPERATURE TROL OF HIGH POWER COMPONENTS ON MULTILAYER						ISSUED	LAMINA
81 SUPF 88 MINI 89 MON 1 TEM 113 COL 114 SHEI 114 SHEI 1 AND DISF 7 MIX 9 LIGH 46 THB 50 Ligh LIGH 51 INC. 58 Ligh 59	C AND LTCC-M BOARDS	UNITED STATES	11/08/03	10/702,957	27-Feb-07	7183640	ISSUED	SAMOTA
88 MINI 89 MON 113 COL TEM 114 SHEI 114 SHEI 115 TUN 119 ELEC A LICI 1 AND DISF 7 MIX 9 LICI 46 THE 50 Ligh LICI 51 INC. 58 Ligh 59	HOD OF FORMING METAL CONTACT PADS ON A METAL PORT SUBSTRATE	UNITED STATES	11/04/99	09/434,058	29-Oct-02	6471805	ISSUED	LAMINA
89 MON TEM 113 COL TEM 114 SHEI TUN 119 ELEC A LII 1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh LIGH EMC 51 INC 58 Ligh 59	IATURE POWER SUPPLY	UNITED STATES	12/18/97	08/993,292	04-Jan-00	6011330	ISSUED	LAMINA
TEM 113 COL TEM 114 SHEI TUN 119 ELES A LIG 1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh LIGH 51 INC. 58 Ligh 59		UNITED STATES	01/08/02	10/041,267	11-Apr-08	7026891	ISSUED	LAMINA
113 COL TEM 114 SHEI TUN 119 ELEC A LIC 1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh LICH 51 INC 58 Ligh 59	NOLITHIC DISC DELAY LINE IPERATURE COMPENSATING DEVICE WITH EMBEDDED	3,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,					LOCUED	LAMINA
114 SHEJ TUN 119 ELEC A LIC 1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh LIGH 51 INC 58 Ligh 59	UMNAR THERMISTORS	UNITED STATES	01/10/02	10/043,733	13-Apr-04	8720859	ISSUED	LANIINA
119 ELEC A LIU 1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh LIGH EMU 51 INC. 58 Ligh	IPERATURE COMPENSATING DEVICE WITH INTEGRAL ET THERMISTORS	UNITED STATES	01/10/02	10/043,582	06-Jul-04	6759940	ISSUED	LAMINA
1 AND DISF 7 MIX 9 LIGH 46 THE 50 Ligh EMU 51 INC. 58 Ligh 59	ABLE BROADSIDE COUPLED TRANSMISSION LINES FOR CTROMAGNETIC WAVES	UNITED STATES	06/06/02	10/164,671	30-Dec-03	6670858	ISSUED	LAMINA
7 MIX 9 LIGH 46 THE 50 Ligh LIGH EMU 51 INC 58 Ligh	IGHT SOURCE WITH OPTIMIZED ELECTRICAL, OPTICAL, DECONOMICAL PERFORMANCE PLAY BACKLIGHT WITH IMPROVED LIGHT COUPLING AN	UNITED STATES	11/08/07	7 11/937,638			PENDING	LAMINA
46 THE 50 Ligh LIGH EMU 51 INC. 58 Ligh		UNITED STATES	08/23/06	11/474,187				D LAMINA
46 THE 50 Ligh LIGH EMU 51 INC. 58 Ligh	HT EFFICIENT LED ASSEMBLY INCLUDING A SHAPED REF	LUNITED STATES		7 11/847,033		la titota i a		D LAMINA D LAMINA
EMU 51 INC. 58 Ligh 59	REMALLY COUPLED LIGHT SOURCE FOR AN IMAGE at emitting diode arrays with Improved light extraction	UNITED STATES UNITED STATES		7 11/875,555 6 11/802,148				D LAMINA
51 INC. 58 Ligh 59	HT EMITTING DIODE PACKAGE ASSEMBLY THAT ULATES THE LIGHT PATTERN PRODUCED BY AN							- 1 114444
58 Ligh 59	ANDESCENT FILAMENT BULB	UNITED STATES		4 10/788,116				D LAMINA LAMINA
PP 0 P	at emitting diode package and method for making same	UNITED STATES UNITED STATES		6 11/475,292 8 12/135,042			PUBLISHE	D LAMINA
. October 1	face mountable light emitting diode assemblies packaged for high	UNITED STATES	C7/12/0:	5 11/179,863				ID LAMINA ID LAMINA
67 Meth 68 Ligh	hod of making optical light engines with elevated LEDs and resulting it emitting diodes with improved light collimatio	g UNITED STATES UNITED STATES		6 11/343,986 6 11/409,847				E LAMINA
90 MIX		UNITED STATES		5 11/445,611				LAMINA In FAMINA
104 MUI	LTI-PRIMARY LED COLLIMATION OPTIC ASSEMBLIES	UNITED STATES	12/26/0	7 11/964,523				ED LAMINA
111 Soli	TICAL DEVICES FOR CONTROLLED COLOR MIXING id state LED bridge rectifier light engine	UNITED STATES		7 11/737,101 6 11/443,535				ED LAMINA ED LAMINA
	ERMALLY-MANAGED LED-BASED RECESSED DOWN	UNITED STATES		7 11/621,131			PUBLISHE	ED LAMINA
115 LIG		UNITED STATES		7 29/284,533		D 572,385	PENDING	LAMINA
72 LIG	HTING FIXTURE	ONLIED SINIES		7 29/284,534			1	

Page 1 of 1

Execution Copy

PATENT ASSIGNMENT

WHEREAS LAMINA LIGHTING, INC., a Delaware corporation, having a place of business at 120 Hancock Lane, Westampton, New Jersey 08060, U.S.A. (hereinafter referred to as ASSIGNOR), has been assigned certain rights, title and interests in and to the patents applications and patents listed in Schedule A hereto and to the inventions described and claimed therein; and

WHEREAS LLI ACQUISITION, INC., a Delaware corporation, having a place of business at 2100 McKinney Avenue, Suite 1515, Dallas, Texas 75201 (hereinafter referred to as ASSIGNEE), is desirous of acquiring ASSIGNOR's entire right, title and interest in and to the patent application and patents in the United States of America and elsewhere worldwide, and the inventions therein described and claimed;

NOW, THEREFORE, in consideration of the good and valuable consideration furnished by ASSIGNOR to ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby assigns, conveys and transfers to ASSIGNEE, its successors and assigns, ASSIGNOR's entire right, title and interest in and to the said patent applications and patents and the inventions therein described and claimed, including its right to apply for any Letters Patent in any and all countries on the inventions, and any Letters Patents that may be or have been issued thereon or therefore, in the United States and elsewhere, and all reissues, extensions, renewals, divisions and continuations thereof, to the full end of the term or terms for which the Letters Patents may be issued or have been issued, the same to be held and enjoyed by ASSIGNEE, its successors and assigns, the same as it would have been held and enjoyed by ASSIGNOR if this Assignment had not been made.

And ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks and similar authorities to issue and transfer all such Letters Patents to ASSIGNEE, its successors and assigns, in accordance with this instrument of Assignment.

ASSIGNOR hereby represents and warrants that there are no rights and interests outstanding inconsistent with the rights and interests granted herein and that it will not execute any instrument or grant or transfer any rights or interests inconsistent therewith, and ASSIGNOR

binds itself to execute and deliver to ASSIGNEE, its successors and assigns, any further documents or instruments and do any and all further acts that may be deemed necessary by ASSIGNEE, its successors and assigns, to vest in ASSIGNEE, its successors and assigns, the title herein conveyed, or intended so to be, and to enable such title to be recorded in the United States and elsewhere.

And ASSIGNOR further covenants and agrees, in consideration of the premises that ASSIGNOR will at any time upon request communicate to ASSIGNEE, its successors and assigns, any facts relating to the invention and improvements and the history thereof, known to ASSIGNOR and that ASSIGNOR will testify as to the same in any interference, or other litigation when requested so to do by ASSIGNEE, its successors and assigns.

IN TESTIMONY WHEREOF, ASSIGNOR has hereunto set its hand and seal this 29th day of July, 2008.

LAMINA LIGHTING, INC.

BY:

Frank Shinneman NAME:

TITLE:

President and Chief Executive Officer

The undersigned is authorized to act on behalf of ASSIGNEE.

IN TESTIMONY WHEREOF, ASSIGNEE has hereunto set its hand and seal this 29th day of July, 2008.

LLI ACQUISITION, INC.

BY:

Govi Rao

TITLE:

NAME:

President

SIGNATURE PAGE TO PATENT ASSIGNMENT (2)

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BY:

NAME:

Govi Rao

TITLE:

President

SIGNATURE PAGE TO PATENT ASSIGNMENT (2)

SCHEDULE A

TITLE CONDUCTIVE VIA FILL INKS FOR CERAMIC MULTILAYER 6 CIRCUIT BOARDS ON SUPPORT SUBSTRATES ELECTRICAL FEEDTHROUGHS FOR CERAMIC CIRCUIT BOAR 10 SUPPORT SUBSTRATES 11 Process for making electrical feedthroughs for ceramic circuit board 12 Electrical feedthroughs for ceramic circuit board support substrates 23 HIGH DIELECTRIC CONSTANT EMBELODED CAPACITORS 24 74 LOW DIELECTRIC CONSTANT EMBELODED CAPACITORS 25 METHOD FOR THE REDUCTION OF LATERAL SHRINKAGE IN 79 MULTILAYER CIRCUIT BOARDS ON A SUBSTRATE 80 Large value buirs dinductors in low temperature co-fired ceramic circuit METHOD TO CONTROL CAVITY DIMENSIONS OF FIRED 33 MULTILAYER CIRCUIT BOARDS ON A SUPPORT 37 Integrated electronic circuit MULTILAYER CIRCUIT BOARDS ON A SUPPORT 38 INTEGRATION OF LATERAL SHRINKAGE IN MULTILAYER CIRCUIT BOARDS ON A SUPPORT 39 HINDERSTORS 40 Multilayer ceramic circuit boards including embedded component MULTILAYER CERAMIC CIRCUIT BOARDS INCLUDING 93 EMBEDDED CAPACITORS 94 Multilayer ceramic circuit boards including embedded component MULTILAYER CERAMIC CIRCUIT HOARDS WITH EMBEDDED 101 RESISTORS 118 THICK CERAMIC ON METAL MULTILAYER CIRCUIT BOARD COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 1 THROUGH ZERNIKE OPTICAL CONTROL SURPACES COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 1 THROUGH ZERNIKE OPTICAL CONTROL SURPACES COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 1 THROUGH ZERNIKE OPTICAL CONTROL SURPACES COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 1 THROUGH ZERNIKE OPTICAL CONTROL SURPACES 105 FOLDED LIGHT PATH LED ARRAY COLLIMATION OPTIC 107 PHOSPHORS LIGHT EMITTING DIODE PACKAGE INCLUDING A NON- 53 STEPPED CAVITY AND METHOD FOR MAKING SAME 123 HIGH EFFICIENCY LIGHT SOURCE WITH INTEGRATED 31 BALLAST LIGHT DISPERSION CONTROL DEVICE FOR MR-16 97 106 107 METHOD OF MAKING OPTICAL LIGHT ENGINES WITH 220 38 40 40 109 SEVEN-CAVITY LED BRIDGE RECTIFIER LIGHT ENGINE 116 120 WARM WHITE LIGHTING DEVICE 26 27 30 30 30 30 31 32 33 34 35 35 36 37 37 37 38 38 39 30 30 30 30 30 30 30 30 30	DOLLER	SCHED	<u> </u>					
6 CIRCUTT BOARDS ON SUPPORT SUBSTRATES ELECTRICAL FEBOTHROUGHS FOR CERAMIC CIRCUIT BOAR 10 SUPPORT SUBSTRATES 11 Process for making electrical feedbroughs for ceramic circuit board 12 Electrical feedbroughs for ceramic circuit board 12 Electrical feedbroughs for ceramic circuit board 12 Electrical feedbroughs for ceramic circuit board support substrate 12 High DIELECTRIC CONSTANT EMBEDDED CAPACITORS 14 14 LOW DIELECTRIC LOSS GLASS CERAMIC COMPOSITIONS 15 16 17 MULTILAYER CIRCUIT BOARDS ON A SUBSTRATE 18 Large value build inductors in fow temperature co-fired certamic circuit 18 MULTILAYER CIRCUIT BOARDS ON A SUBSTRATE 18 MULTILAYER CIRCUIT BOARDS ON A SUPPORT 18 Integrated electronic circuit 19 MULTILAYER CERAMIC CIRCUIT BOARDS INCLUDING 19 BMBEDDED CAPACITORS 10 Multilayer ceramic circuit boards including embedded component 10 MULTILAYER CERAMIC CIRCUIT BOARDS WITH EMBEDDED 10 RESISTORS 118 THICK CERAMIC ON METAL MULTILAYER CIRCUIT BOARD 10 COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 10 THROUGH ZEMIKE OPTICAL CONTROL SURPACES 10 COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 11 THROUGH ZEMIKE OPTICAL CONTROL SURPACES 10 FOLDED LIGHT PATH LED ARRAY COLLIMATION OPTIC 11 USING MULTIL WAYELENGTH PUMP SOURCES AND MIXED 19 PHOSPHORS 1 LIGHT EMITTING DIODE PACKAGE INCLUDING A NON- 25 STEPPED CAVITY AND METHOD FOR MAKING SAME 123 11 HIGH EFFICIENCY LIGHT SOURCE WITH INTEGRATED 11 BALLAST 1 LIGHT DISPERSION CONTROL DEVICE FOR MR-16 12 TREET LAMP RETROFIT K.T 10 SEVEN-CAVITY LED ARRAY RGP COLLIMATION OPTIC 11 STREET LAMP RETROFIT K.T 16 SEVEN-CAVITY LED ARRAY RGP COLLIMATION OPTIC 12 STREET LAMP RETROFIT K.T 16 SEVEN-CAVITY LED ARRAY RGP COLLIMATION OPTIC 11 STREET LAMP RETROFIT K.T 16 SELEVATED LEDS AND RESULTING PRODUCTS 16 SELEVATED LEDS AND RE	COUNTRY	COUNTRY	FILE DATE	SERIAL NO	ISSUE DATE	PATENT NO	STATUS	Assignment
10 SUPPORT SUBSTRATES 11 Process for making electrical feedthroughs for ceramic circuit board 12 Electrical feedthroughs for ceramic circuit board support substrates 23 HIGH DIELECTRIC CONSTANT EMBEDDED CAPACITORS 24 74 LOW DIELECTRIC LOSS GLASS CERAMIC COMPOSITIONS METHOD FOR THE REDUCTION OF LATERAL SHRINKAGE IN 79 MULTILAYER CIRCUIT BOARDS ON A SUBSTRATE 80 Large value buried inductors in few temperature co-fired certainic circuit METHOD TO CONTROL CAVITY DIMENSIONS OF FIRED 33 MULTILAYER CIRCUIT BOARDS ON A SUBSTRATE 83 MULTILAYER CERAMIC CIRCUIT BOARDS INCLUDING 94 Multilayer ceramic circuit boards including embedded component MULTILAYER CERAMIC CIRCUIT BOARDS WITH EMBEDDED 101 RESISTORS 118 THICK CERAMIC ON METAL MULTILAYER CIRCUIT BOARD COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 4 THROUGH ZEMIKE OPTICAL CONTROL SURPACES COLOR AND SPATIAL UNIFORMITY ENHANCEMENT 14 THROUGH ZEMIKE OPTICAL CONTROL SURPACES 16 FOLDED LIGHT PATH LED ARRAY COLLIMATION OPTIC USING MULTI-WAVELENGTH PUMP SOURCES AND MIXED 19 PHOSPHORS LIGHT EMITTING DIODE PACKAGE INCLUDING A NON- 53 STEPPED CAVITY AND METHOD FOR MAKING SAME 123 HIGH EFFICIENCY LIGHT SOURCE WITH INTEGRATED 31 BALLAST LIGHT DISPERSION CONTROL DEVICE FOR MR-16 47 REPLACEMENT 109 SEVEN-CAVITY LED ARRAY RGB COLLIMATION OPTIC 112 STREET LAMP RETROFIT K'T 109 107 107 108 METHOD OF MAKING OPTICAL LIGHT ENGINES WITH 82 ELEVATED LEDS AND RESULTING PRODUCTS 86 97 100 108 109 109 109 109 109 109	UNITED STATES	UNITED STATES	01/27/95	08/379,265	07-May-96	5514451	ISSUED	LAMINA
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47 REPLACEMENT	UNITED STATES	UNITED STATES	10/26/07	80/963,043			PENDING	LAMINA
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18	UNITED STATES	UNITED STATES	10/01/07	60/976,893			PENDING	LAMINA
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108 110 SOLID STATE LED BRIDGE RECTIFIER LIGHT ENGINE 116 120 WARM WHITE LIGHTING DEVICE 25 26 29 30 36 43 43 55 62	TAIWAN			87103293	11-Sep-00	NI-120124	ISSUED	LAMINA/Sharp
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62	JAPAN		06/27/06		 	_	PENDING	LAMINA LAMINA
	JAPAN		04/26/04		07-Mar-03	3405545	PENDING ISSUED	LAMINA/Sharp
84 MICROWAVE INTEGRATED CIRCUIT 96	JAPAN JAPAN		10/30/97 03/03/98		20-Apr-07		ISSUED	LAMINA/Sharp

Page 1 of 2

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Item	TITLE	COUNTRY	DATE	SERIAL NO	DATE	PATENT NO		Assignment
97		JAPAN	03/03/98	2005-368893				LAMINA/Sharp
37		SOUTH KOREA	07/01/05	7002836/2008				LAMINA
44		SOUTH KOREA	07/13/05	2007-7003310			PENDING	LAMINA
49		SQUITH KOREA	04/11/05	2008-7023416			PUBLISHED	
		SOUTH KOREA	06/27/06	7002151/2008				LAMINA
56 63		SOUTH KOREA	04/26/04	10-2005-7020631				LAMINA
		SOUTH KOREA	10/30/97	1999-7003713	25-Jan-07	677005	ISSUED	LAMINA/Sharp
85		SOUTH KOREA		1999-7008082	13-Sep-05	516043	ISSUED	LAMINA/Sharp
98		SOUTH KOREA		2005-7006663	19-Jan-08	546471	ISSUED	LAMINA/Sharp
99		SOUTH KOREA	02/09/00	10-2001-7010074			PENDING	LAM:NA/Sharp
103		MEXICO		PA/e/2001/003349	21-Jun-05	228623	ISSUED	LAMINA/Daewoo
27		MEXICO		PA/e/2001/003350	2,52		PUBLISHED	LAMINA/Daewoo
28		MEXICO	10/01/08	F TANKED HADDAGE	+	·		
35		EUROPEAN PATENT CNVT.	07/01/05	5769328.5			PUBLISHED	LAMINA
42		EUROPEAN PATENT CNVT.	07/13/05	5770935.4			PUBLISHED	LAMINA
	LIGHT EMITTING DIODE ARRAYS WITH IMPROVED LIGHT	EUROPEAN PATENT CNVT.	04/1 1/05	5736416.B			PUBLISHED	LAMINA
54		EUROPEAN PATENT CHVT.					PUBLISHED	LAMINA
61		EUROPEAN PATENT CNVT.	04/26/04	4750631.6	ļ		PUBLISHED	LAMINA
95		EUROPEAN PATENT CNVT.	G3/D3/98	98910019.3			PUBLISHED	LAMINA/Sharp
102		EUROPEAN PATENT CNVT.	02/09/00	913404	<u> </u>	<u></u>	PUBLISHED	LAMINA/Sharp

Page 2 of 2

PATENT REEL: 023024 FRAME: 0117

RECORDED: 07/29/2009